



CPT20013

FANLESS IP66 IN-VEHICLE COMPUTER WITH INTEL® RAPTOR LAKE-S REFRESH 14/13TH GEN SOCKET PROCESSOR



- Intel® Raptor Lake-S Core™ i Processor
- NVIDIA L4 GPU
- DDR5-4800 SO-DIMM up to 96G (non-ECC /ECC)
- 4 x 2.5GbE LAN w/M12
- 2 x RS232/422/485 w/M12
- 4 x RJ45 Intel i210-IT GbE LAN with PoE+ w/M12
- 2 x CANBus 2.0B, 8-bit Isolated DIDO w/M12
- 2 x 10GbE LAN w/M12
- 1 x DC-IN w/M12
- M20 Connectors: 1 x USB 3.0, 1 x MiniDP
- 2 x Internal 2.5" SSD Tray
- Operating Temperature -20°C to 60°C
- MIL-STD-810 Standards for Shock, Vibration and Wide Temperatures

Introduction

The IP66 Fanless In-Vehicle GPU Computer CPT200X3 Series is engineered for mission-critical edge applications that demand both performance and durability. Equipped with the latest Intel® Raptor Lake-S Core™ i Processor and NVIDIA L4 GPU with supporting up to 96GB of DDR5-4800 SO-DIMM, it provides the computing power required for real-time AI workloads, machine vision, and autonomous control. Its rugged, fanless design ensures reliable, silent operation in even the most challenging environmental conditions.

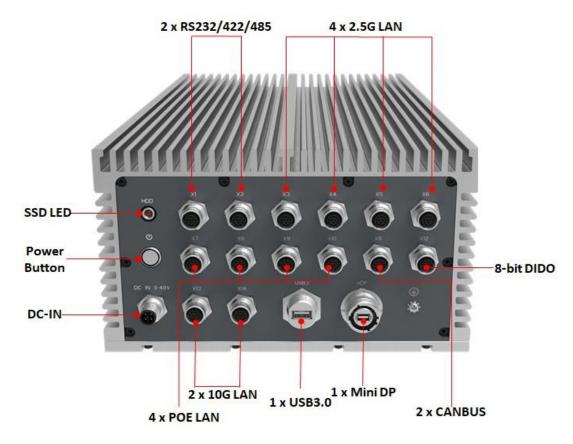
Designed for autonomous electric mining trucks, robotic arms, and other industrial automation systems, the CPT200X3 provides a robust platform for next-generation smart machinery. With IP66-rated protection, it withstands dust, water, and extreme conditions, and the MIL-STD-810 standards ensures resilience against shock, vibration, and wide temperature ranges from -20°C to 60°C.

Connectivity and flexibility are at the heart of the CPT200X3. Equipped with M12 connectors, it offers 4 \times 2.5GbE LAN, 2 \times RS232/422/485, 4 \times PoE LAN, 2 \times 10G LAN, and 2 \times CANBUS/8 Bit DIDO, along with 1 \times USB3.0 and 1 \times MiniDP w/M20 for high-resolution display output. It also supports dual 2.5" SSD trays, enabling high-capacity, fast-access storage for data-intensive applications such as sensor fusion, video analytics, and Al inference at the edge.

With its rugged construction, advanced processing capabilities, and versatile connectivity, the CPT200X3 series delivers a robust solution for industrial in-vehicle GPU computing. Whether powering autonomous fleets in mining operations or enabling high-precision robotics in factories, the CPT200X3 series is built to deliver reliability, efficiency, and performance under the most demanding conditions.

Appearance

CPT200X3 Front IO



CPT200X3 Series Rear IO



Specifications

SY	3TE	M
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CPU	14th/13th/12th Gen Intel® Raptor Lake-S/Alder Lake-S Core i9/i7/i5/i3/Celeron/Pentium (Up to 35W)						
Chipset	Intel® R680E						
GPU	1 x NVIDIA L4						
Memory type	2 x 262-pin SO-DIMM / DDR5 4800 MHz / Max. 96 GB (Non-ECC/ ECC)						
Storage Device	2 x 2.5" Internal SSD Tray						
EXPANSION							
M.2	1 x M.2 M key 2242/2260/2280 (PCle4.0x4,SATAIII) w/OS Storage 1 x M.2 B key 3042/3052/2260 (PClex1,USB,SATAIII) w/4G,5G 1 x M.2 E key 2230 (PClex1,USB) w/Wi-Fi, BT 1 x mPCle (PClex1,USB,SATAIII)						
FRONT I/O							
COM	2 x RS232/422/485 w/2 x M12						
LAN	4 x 2.5GbE LAN w/4 x M12						
PoE	4 x PoE LAN w/4 x M12						
CANBUS	2 x CANBUS w/1 x M12						
DIDO	1 x 8-bit DIDO w/1 x M12						
USB3.0	1 x USB3.0 w/1 x M20						
Display	1 x MiniDP w / 1 x M20						
Power Input	1 x DC-IN w/ 1 x M12(9~48V)						
REAR I/O							
(Option) Antenna	6 x Water-proof SMA Connector						
POWER REQUIRE	MENT						
Power Input	DC-IN 9~48V						
OPERATING SYS	TEM						
Operating System	Windows 10/11 64Bit Linux (support by request)						

PHYSICAL & ENVIRONMENT

Dimensions (W x D x H)	248 x 425 x 141.2 mm					
IP	IP66 designed to meet					
Green Product	RoHS designed to meet					
Operating Temperature	35W TPD Processor: -20°C to 60°C					
Storage Temperature	-40°C to 85°C					
Relative Humidity	5% to 95%, non-condensing					
EMC	CE and FCC designed to meet					
MIL-STD-810 ENVIRONMENT TESTING STANDARDS						
Method 501,						
Operational	Procedure II: +60°C, two-hour dwell, four cycles					
Temperature, High						
Method 501, Storage	Dragodura le 170°C truo hour duall four suclos					
Temperature, High	Procedure I: +70°C, two-hour dwell, four cycles					
Method 502,						
Operational	Procedure II: -20°C, two-hour dwell, four cycles					
Temperature, Low						
Method 502, Storage	Procedure I: -30°C, two-hour dwell, four cycles					
Temperature, Low	Frocedure 1: -30 C, two-flodi dwell, four cycles					
Method 514, Vibration	Category 24/Non-Operating (Category 20 & 24, Vibration)					
Method 514, Vibration	Category 20/Operating (Category 20 & 24, Vibration)					
Method 516, Shock	Procedure V Non-Operating (Mechanical Shock)					
Method 516, Shock	Procedure I Operating (Mechanical Shock)					
Method 507, Humidity	Procedure II: exposure to 10 cycles of 95% relative humidity at temperatures of 30 °C to 60 °C with conformal coating (optional)					

Ordering Information

CPT200X3

Fanless Embedded In-Vehicle GPU System with Intel® 14/13/12th Gen Core™ i9/i7/i5/i3 Processor up to 65W , 96G SO-DIMM DDR5 4800MHz, 4×2.5 GbE RJ45 w/M12, $2 \times RS232/422/485$ w/M12, $1 \times miniDP$ w/M20, $1 \times USB3.0$ w/M20, 2×10 G w/M12, $4 \times POE$ w/M12, $2 \times CANBUS/8$ Bit DIDO w/M12, $2 \times Internal SSD$ Tray, 1×72 W NVIDIA L4, $1 \times DC$ -IN w/M12, $9 \sim 48$ V, Operating Temperature -20°C to +60°C

Model	CPT200X3-i5-R1	CPT20	0X3-i5-R2	CPT200X3-i7-R1	CPT20	00X3-i7-R2	CPT200X3-i9-R1		CPT200X3-i9-R2
CPU	i5-14501TE	i5-1	3500TE	i7-14701TE	17-1	3700TE	i9-14901TE		i9-13900TE
	Function		Q'ty			Item		Have Y / N	
	2.5GbE LAN		4			X3~X6 w/M12		Υ	
	GbE POE		4			X7~X10 w/M12		Y	
	10GbE LAN		2			X13~X14 w/M12		Y	
	RS232/422/485		2			X1~X2 w/M12		Υ	
	CANBUS(1 to 2)		1			X11 w/M12		Υ	
	8-bit DIDO		1			X12 w/M12		Y	
	MiniDP		1			Mini DP w/M20		Υ	
	USB3.0		1			USB3.0 w/M20			Υ

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